

CMOS Power

Outline

- Power and Energy
- Dynamic Power
- ☐ Static Power

Power and Energy

- □ Power is drawn from a voltage source attached to the V_{DD} pin(s) of a chip.
- ☐ Instantaneous Power: P(t) = I(t)V(t)
- \Box Energy: $E = \int_{0}^{t} P(t)dt$
- Average Power: $P_{\text{avg}} = \frac{E}{T} = \frac{1}{T} \int_{0}^{T} P(t) dt$

Power in Circuit Elements

$$P_{VDD}\left(t\right) = I_{DD}\left(t\right)V_{DD}$$

$$P_{R}(t) = \frac{V_{R}^{2}(t)}{R} = I_{R}^{2}(t)R$$

$$E_C = \int_0^\infty I(t)V(t)dt = \int_0^\infty C\frac{dV}{dt}V(t)dt$$
$$= C\int_0^{V_C} V(t)dV = \frac{1}{2}CV_C^2$$

$$\overset{+}{\bigvee}_{C} + \overset{+}{\longleftarrow} C \downarrow I_{C} = C \text{ dV/dt}$$

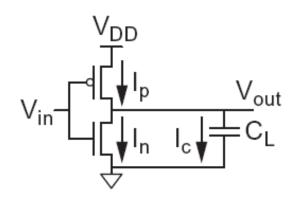
Charging a Capacitor

- When the gate output rises
 - Energy stored in capacitor is

$$E_C = \frac{1}{2} C_L V_{DD}^2$$

But energy drawn from the supply is

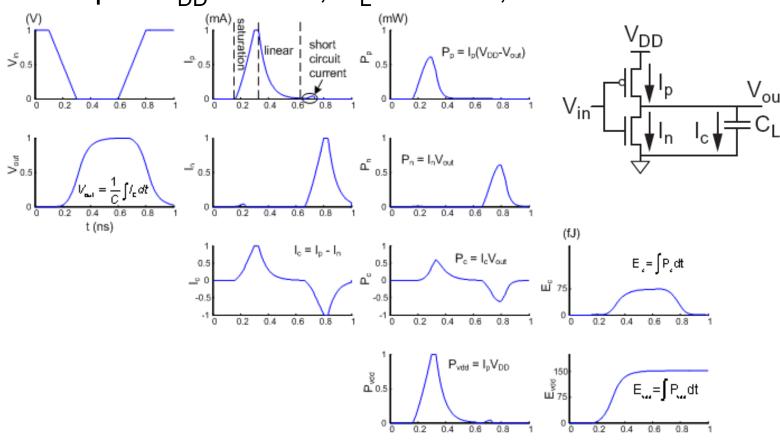
$$E_{VDD} = \int_{0}^{\infty} I(t)V_{DD}dt = \int_{0}^{\infty} C_{L} \frac{dV}{dt}V_{DD}dt$$
$$= C_{L}V_{DD} \int_{0}^{V_{DD}} dV = C_{L}V_{DD}^{2}$$



- Half the energy from V_{DD} is dissipated in the pMOS transistor as heat, other half stored in capacitor
- When the gate output falls
 - Energy in capacitor is dumped to GND
 - Dissipated as heat in the nMOS transistor

Switching Waveforms

 \Box Example: $V_{DD} = 1.0 \text{ V}$, $C_L = 150 \text{ fF}$, f = 1 GHz



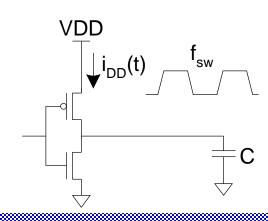
Switching Power

$$P_{\text{switching}} = \frac{1}{T} \int_{0}^{T} i_{DD}(t) V_{DD} dt$$

$$= \frac{V_{DD}}{T} \int_{0}^{T} i_{DD}(t) dt$$

$$= \frac{V_{DD}}{T} \left[T f_{\text{sw}} C V_{DD} \right]$$

$$= C V_{DD}^{2} f_{\text{sw}}$$



Activity Factor

- ☐ Suppose the system clock frequency = f
- \Box Let $f_{sw} = \alpha f$, where $\alpha =$ activity factor
 - If the signal is a clock, $\alpha = 1$
 - If the signal switches once per cycle, $\alpha = \frac{1}{2}$
- Dynamic power:

$$P_{\text{switching}} = \alpha C V_{DD}^2 f$$

Short Circuit Current

- When transistors switch, both nMOS and pMOS networks may be momentarily ON at once
- Leads to a blip of "short circuit" current.
- < 10% of dynamic power if rise/fall times are comparable for input and output
- We will generally ignore this component

Power Dissipation Sources

- Dynamic power: P_{dynamic} = P_{switching} + P_{shortcircuit}
 - Switching load capacitances
 - Short-circuit current
- \square Static power: $P_{\text{static}} = (I_{\text{sub}} + I_{\text{gate}} + I_{\text{junct}} + I_{\text{contention}})V_{\text{DD}}$
 - Subthreshold leakage
 - Gate leakage
 - Junction leakage
 - Contention current

Dynamic Power Example

- ☐ 1 billion transistor chip
 - 50M logic transistors
 - Average width: 12 λ
 - Activity factor = 0.1
 - 950M memory transistors
 - Average width: 4 λ
 - Activity factor = 0.02
 - 1.0 V 65 nm process
 - $-C = 1 \text{ fF/}\mu\text{m} \text{ (gate)} + 0.8 \text{ fF/}\mu\text{m} \text{ (diffusion)}$
- ☐ Estimate dynamic power consumption @ 1 GHz. Neglect wire capacitance and short-circuit current.

Solution

$$C_{\text{logic}} = (50 \times 10^6)(12\lambda)(0.025 \mu m / \lambda)(1.8 fF / \mu m) = 27 \text{ nF}$$

$$C_{\text{mem}} = (950 \times 10^6)(4\lambda)(0.025 \mu m / \lambda)(1.8 fF / \mu m) = 171 \text{ nF}$$

$$P_{\text{dynamic}} = \left[0.1C_{\text{logic}} + 0.02C_{\text{mem}}\right](1.0)^2 (1.0 \text{ GHz}) = 6.1 \text{ W}$$

Dynamic Power Reduction

- $P_{\text{switching}} = \alpha C V_{DD}^2 f$
- ☐ Try to minimize:
 - Activity factor
 - Capacitance
 - Supply voltage
 - Frequency